SCAS215B - JANUARY 1988 - REVISED JUNE 1997

<ul> <li>Inputs Are TTL-Voltage Compatible</li> <li>Flow-Through Architecture Optimizes PCB</li> </ul>	DB, DW, N, OR PW PACKAGE (TOP VIEW)
Layout	1Y 1 20 1A
<ul> <li>Center-Pin V<sub>CC</sub> and GND Configurations</li></ul>	2Y [] 2 19 [] 2A
Minimize High-Speed Switching Noise	3Y [] 3 18 [] 3A
<ul> <li>EPIC<sup>™</sup> (Enhanced-Performance Implanted</li></ul>	GND [] 4 17 ]] NC
CMOS) 1-µm Process	GND [] 5 16 ]] V <sub>CC</sub>
<ul> <li>500-mA Typical Latch-Up Immunity at</li></ul>	GND [] 6 15 ]] V <sub>CC</sub>
125°C	GND [] 7 14 ]] NC
<ul> <li>Package Options Include Plastic</li></ul>	4Y [] 8 13 [] 4A
Small-Outline (DW), Shrink Small-Outline	5Y [] 9 12 [] 5A
(DB), and Thin Shrink Small-Outline (PW)	6Y [] 10 11 [] 6A
Packages and Standard Plastic (N) 300-mil DIPs	NC – No internal connection

#### description

This device contains six independent inverters. It performs the Boolean function  $Y = \overline{A}$ .

The 74ACT11004 is characterized for operation from -40°C to 85°C.

FUNCTION TABLE (each inverter)					
INPUT A	OUTPUT Y				
Н	L				
L	Н				

## logic symbol<sup>†</sup>

1A	20	1		1Y
	19	•	2	
2A	18		3	2Y
3A	13		8	3Y 4Y
4A	12		9	
5A	11		10	5Y
6A			<u> </u>	6Y

<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

EPIC is a trademark of Texas Instruments Incorporated.

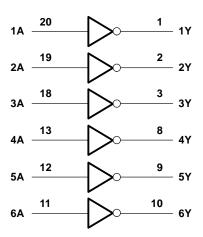
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



Copyright © 1997, Texas Instruments Incorporated

SCAS215B - JANUARY 1988 - REVISED JUNE 1997

## logic diagram (positive logic)



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, V <sub>CC</sub>		
Input voltage range, V <sub>I</sub> (see Note 1)		
Output voltage range, V <sub>O</sub> (see Note 1)		–0.5 V to V <sub>CC</sub> + 0.5 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ).		±20 mA
Output clamp current, $I_{OK}$ (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CO</sub>	с)	±50 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	-	±50 mA
Continuous current through V <sub>CC</sub> or GND		±150 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2)	): DB package	115°C/W
	DW package	
	N package	67°C/W
	PW package	128°C/W
Storage temperature range, T <sub>stg</sub>		

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

#### recommended operating conditions

		MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage	4.5	5.5	V
VIH	High-level input voltage	2		V
VIL	Low-level input voltage		0.8	V
VI	Input voltage	0	VCC	V
VO	Output voltage	0	VCC	V
IОН	High-level output current		-24	mA
IOL	Low-level output current		24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10	ns/V
Τ <sub>Α</sub>	Operating free-air temperature	-40	85	°C



SCAS215B - JANUARY 1988 - REVISED JUNE 1997

DADAMETED	TEST CONDITIONS	Vac	T <sub>A</sub> = 25°C						
PARAMETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	UNIT	
	1 50.04	4.5 V	4.4			4.4			
	I <sub>OH</sub> = -50 μA	5.5 V	5.4			5.4			
VOH		4.5 V	3.94			3.8		V	
	I <sub>OH</sub> = -24 mA	5.5 V	4.94			4.8			
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85			
Voi	I <sub>OL</sub> = 50 μA	4.5 V			0.1		0.1		
		5.5 V			0.1		0.1		
	I <sub>OL</sub> = 24 mA	4.5 V			0.36		0.44	V	
		5.5 V			0.36		0.44		
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V					1.65		
Ц	$V_{I} = V_{CC}$ or GND	5.5 V			±0.1		±1	μΑ	
Icc	$V_{I} = V_{CC} \text{ or GND}, \qquad I_{O} = 0$	5.5 V			4		40	μΑ	
$\Delta$ ICC <sup>‡</sup>	One input at 3.4 V, Other inputs at GND or $V_{CC}$	5.5 V			0.9		1	mA	
Ci	$V_I = V_{CC}$ or GND	5 V		3.5				pF	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

<sup>†</sup>Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ns.

<sup>‡</sup>This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V<sub>CC</sub>.

# switching characteristics over recommended ranges of supply voltage and free-air temperature (unless otherwise noted) (see Figure 1)

PARAMETER	PARAMETER FROM TO (INPUT) (OUTPUT)	T <sub>A</sub> = 25°C			MIN	MAY	мах	UNIT
		(OUTPUT)	MIN	TYP	MAX			IVIAA
<sup>t</sup> PLH	٨	v	1.5	5.3	9	1.5	9.7	<b>DC</b>
<sup>t</sup> PHL	A	Ŷ	1.5	6.4	8.7	1.5	9.6	ns

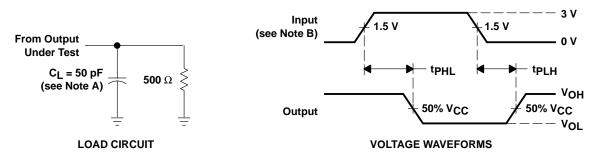
## operating characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

	PARAMETER	TEST CONDITIONS		TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance per inverter	C <sub>L</sub> = 50 pF,	f = 1 MHz	32	pF



SCAS215B - JANUARY 1988 - REVISED JUNE 1997

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub> = 3 ns, t<sub>f</sub> = 3 ns.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



#### **IMPORTANT NOTICE**

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgment, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Customers are responsible for their applications using TI components.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, license, warranty or endorsement thereof.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations and notices. Representation or reproduction of this information with alteration voids all warranties provided for an associated TI product or service, is an unfair and deceptive business practice, and TI is not responsible nor liable for any such use.

Resale of TI's products or services with <u>statements different from or beyond the parameters</u> stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service, is an unfair and deceptive business practice, and TI is not responsible nor liable for any such use.

Also see: Standard Terms and Conditions of Sale for Semiconductor Products. www.ti.com/sc/docs/stdterms.htm

Mailing Address:

Texas Instruments Post Office Box 655303 Dallas, Texas 75265

Copyright © 2001, Texas Instruments Incorporated